

## P4404ET-VB Datasheet

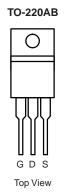
## P-Channel 40 V (D-S) MOSFET

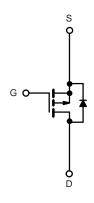
PRODUC	T SUMMARY	
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>a</sup>
- 40	0.012 at $V_{GS}$ = - 10 V	± 65
- 40	0.014 at V <sub>GS</sub> = - 4.5 V	± 60

#### FEATURES

Compliant to RoHS Directive 2002/95/EC







P-Channel MOSFET

ABSOLUTE MAXIMUM RAT	<b>INGS</b> ( $T_C = 25 \text{ °C}$ , unless other	wise noted)		
Parameter		Symbol	Limit	Unit
Gate-Source Voltage	V <sub>GS</sub>	± 40	V	
Continuous Drain Current (T <sub>1</sub> = 175 °C)	T <sub>C</sub> = 25 °C	I	- 65 <sup>a</sup>	
Continuous Drain Current $(T_j = T/5 C)$	T <sub>C</sub> = 125 °C	I <sub>D</sub>	- 62	A
Pulsed Drain Current		I <sub>DM</sub>	- 60	A .
Avalanche Current		I <sub>AR</sub> - 60		1
Repetitive Avalanche Energy <sup>b</sup>	L = 0.1 mH	E <sub>AR</sub>	180	mJ
Power Dissinction	T <sub>C</sub> = 25 °C (TO-220AB and TO-263)	D	187 <sup>d</sup>	W
Power Dissipation	T <sub>A</sub> = 25 °C (TO-263) <sup>c</sup>	P <sub>D</sub>	3.75	VV
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 175	°C

THERMAL RESISTANCE	RATINGS			
Parameter		Symbol	Limit	Unit
Junction-to-Ambient	PCB Mount (TO-263) <sup>c</sup>	Р	40	
Sunction-to-Ambient	Free Air (TO-220AB)	– R <sub>thJA</sub>	62.5	°C/W
Junction-to-Case		R <sub>thJC</sub>	0.8	

Notes:

a. Package limited.

b. Duty cycle  $\leq$  1 %.

c. When mounted on 1" square PCB (FR-4 material).

d. See SOA curve for voltage derating.

\* Pb containing terminations are not RoHS compliant, exemptions may apply.



<b>SPECIFICATIONS</b> ( $T_J = 25$	°C, unless o	otherwise noted)					
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_{D} = -250 \mu A$	- 40			V	
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1.5		- 1.7	v	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ = - 30 V, $V_{GS}$ = 0 V, $T_{J}$ = 125 °C			- 50	μA	
		$V_{DS}$ = - 30 V, $V_{GS}$ = 0 V, $T_{J}$ = 175 °C			- 250		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} = -5 V, V_{GS} = -10 V$	- 120			А	
		V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 30 A		0.012			
Drain-Source On-State Resistance <sup>a</sup>	Б	$V_{GS}$ = - 10 V, I <sub>D</sub> = - 30 A, T <sub>J</sub> = 125 °C		0.010		0	
Dian-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 30 A, T <sub>J</sub> = 175 °C		0.013		μA	
		V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 20 A		0.014			
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 15 V, I <sub>D</sub> = - 75 A	20			S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>			9000		pF	
Output Capacitance	C <sub>oss</sub>	$V_{DS} = -15$ V, $I_D = -75$ A 20 $V_{GS} = 0$ V, $V_{DS} = -25$ V, $f = 1$ MHz		1565			
Reversen Transfer Capacitance	C <sub>rss</sub>			715			
Total Gate Charge <sup>c</sup>	Qg			160	240		
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	V <sub>DS</sub> = - 15 V, V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 75 A		32		nC	
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>			30			
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			25	40		
Rise Time <sup>c</sup>	tr	V <sub>DD</sub> = - 15 V, R <sub>I</sub> = 0.2 Ω		225	360	ns	
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong -75$ Å, $V_{GEN} = -10$ V, $R_g = 2.5 \Omega$		150	240		
Fall Time <sup>c</sup>	t <sub>f</sub>			210	340	I	
Source-Drain Diode Ratings and Cha	racteristics <sup>b</sup>	(T <sub>C</sub> = 25 °C)					
Continuous Current	۱ <sub>S</sub>				- 80		
Pulsed Current	I <sub>SM</sub>				- 240	A	
Forward Voltage <sup>a</sup>	V <sub>SD</sub>	I <sub>F</sub> = - 75 A, V <sub>GS</sub> = 0 V		- 1.2	- 1.5	V	
Reverse Recovery Time	t <sub>rr</sub>			55	100	ns	
Peak Reverse Recovery Current	I <sub>RM(REC)</sub>	I <sub>F</sub> = - 75 A, dl/dt = 100 A/μs		2.5	5	А	
Reverse Recovery Charge	Q <sub>rr</sub>	1		0.07	0.25	μC	

Notes:

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

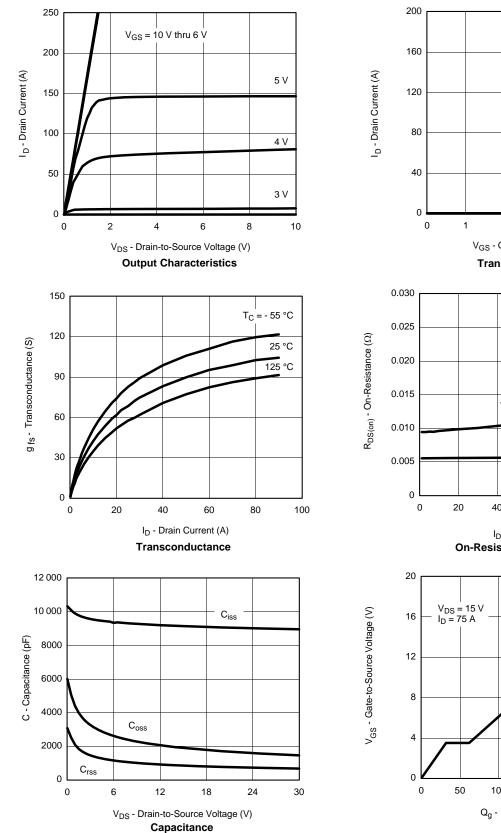
b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

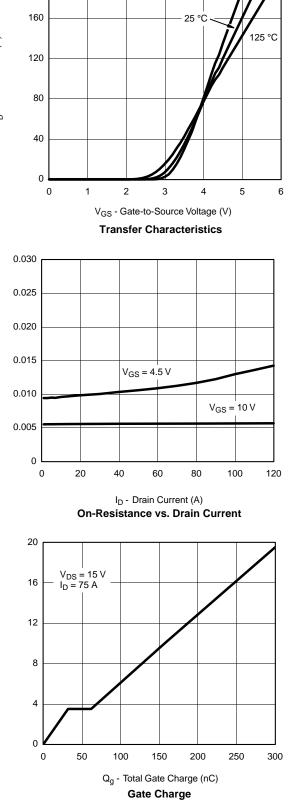
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



T<sub>C</sub> = - 55 °C

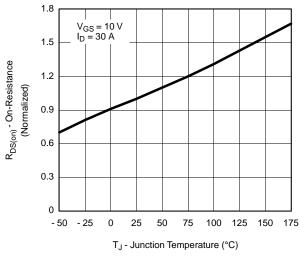


### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

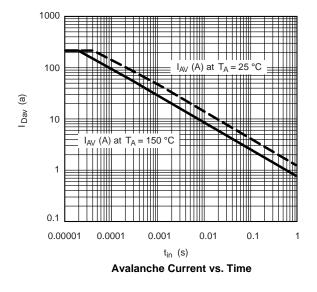


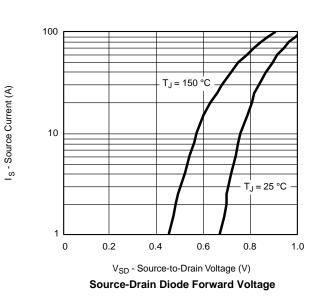


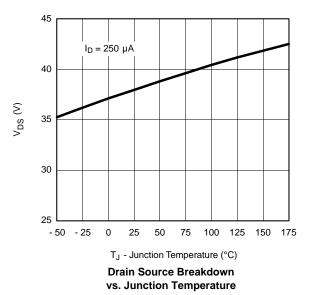
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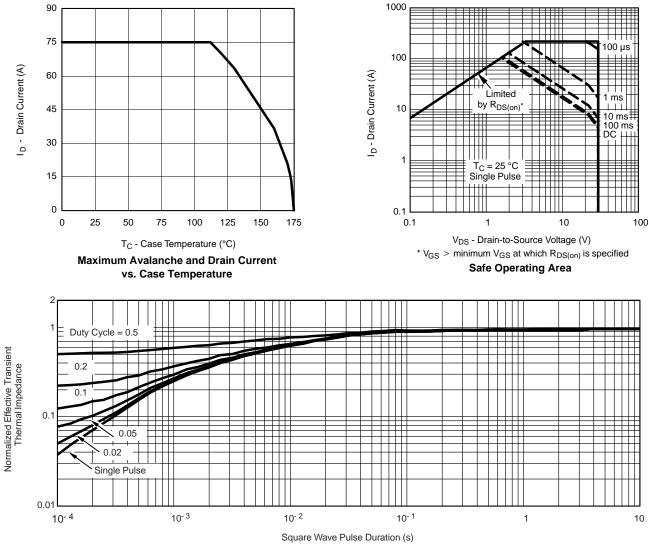








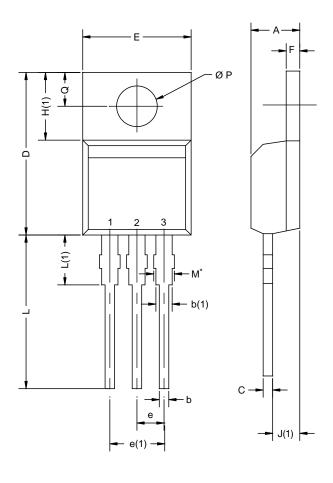
#### **THERMAL RATINGS**



Normalized Thermal Transient Impedance, Junction-to-Case



## **TO-220AB**



DIM.	MILLIM	MILLIMETERS		HES
	MIN.	MAX.	MIN.	MAX.
А	4.25	4.65	0.167	0.183
b	0.69	1.01	0.027	0.040
b(1)	1.20	1.73	0.047	0.068
С	0.36	0.61	0.014	0.024
D	14.85	15.49	0.585	0.610
Е	10.04	10.51	0.395	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.09	6.48	0.240	0.255
J(1)	2.41	2.92	0.095	0.115
L	13.35	14.02	0.526	0.552
L(1)	3.32	3.82	0.131	0.150
ØР	3.54	3.94	0.139	0.155
Q	2.60	3.00	0.102	0.118

#### Notes

\* M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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